

Features

- Industry-standard Architecture
- 12ns Maximum Pin-to-pin Delay
- Zero Power – 100µA Maximum Standby Power (Input Transition Detection)
- CMOS and TTL Compatible Inputs and Outputs
- Advanced Electrically Erasable Technology
 - Reprogrammable
 - 100% Tested
- Latch Feature Holds Inputs to Previous Logic State
- High-reliability CMOS Process
 - 20 Year Data Retention
 - 100 Erase/Write Cycles
 - 2,000V ESD Protection
 - 200mA Latchup Immunity
- Industrial Temperature Ranges
- Dual-in-line and Surface Mount Standard Pinouts
- PCI Compliant
- Green Package Options (Pb/Halide-free/RoHS Compliant) Available

1. Description

The Atmel® ATF22V10CZ/CQZ is a high-performance CMOS (electrically erasable) programmable logic device (PLD) which utilizes The Atmel proven electrically erasable Flash memory technology. Speeds down to 12ns with zero standby power dissipation are offered. All speed ranges are specified over the full 5V ±10% range for industrial temperature ranges; 5V ±5% for commercial range 5-volt devices. The ATF22V10CZ/CQZ provides a low voltage and edge-sensing “zero” power CMOS PLD solution with “zero” standby power (5µA typical). The ATF22V10CZ/CQZ provides a “zero” power CMOS PLD solution with 5V operating voltages, powering down automatically to the zero power-mode through The Atmel patented Input Transition Detection (ITD) circuitry when the device is idle, offering “zero” (100µA worst case) standby power. This feature allows the user to manage total system power to meet specific application requirements and enhance reliability. Pin “keeper” circuits on input and output pins eliminate static power consumed by pull-up resistors. The “CQZ” combines the low high-frequency I_{CC} of the “Q” design with the “Z” feature.

The ATF22V10CZ/CQZ incorporates a superset of the generic architectures, which allows direct replacement of the 22V10 family and most 24-pin combinatorial PLDs. Ten outputs are each allocated 8 to 16 product terms. Three different modes of operation, configured automatically with software, allow highly complex logic functions to be realized.



**High-performance
Electrically
Erasable
Programmable
Logic Device**

**Atmel ATF22V10CZ
Atmel ATF22V10CQZ**

**ATF22V10CZ is
Not Recommended for New
Design. Replaced by
ATF22V10CQZ.**



Figure 1-1. Block Diagram



2. Pin Configurations

Table 2-1. Pin Configurations (All Pinouts Top View)

| Pin Name | Function |
|----------|------------------------|
| CLK | Clock |
| IN | Logic Inputs |
| I/O | Bi-directional Buffers |
| VCC | +5V Supply |

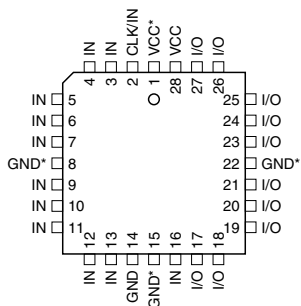
Figure 2-1. TSSOP



Figure 2-2. DIP/SOIC



Figure 2-3. PLCC



Note: For PLCC, P1, P8, P15 and P22 can be left unconnected. For superior performance, connect VCC to pin 1 and GND to 8, 15, and 22

3. Absolute Maximum Ratings*

| | |
|--|--------------------------------|
| Temperature Under Bias | -40°C to +85°C |
| Storage Temperature..... | -65°C to +150°C |
| Voltage on Any Pin with Respect to Ground..... | -2.0V to +7.0V ⁽¹⁾ |
| Voltage on Input Pins with Respect to Ground During Programming..... | -2.0V to +14.0V ⁽¹⁾ |
| Programming Voltage with Respect to Ground..... | -2.0V to +14.0V ⁽¹⁾ |

*NOTICE: Stresses beyond those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Note: 1. Minimum voltage is -0.6V DC, which may undershoot to -2.0V for pulses of less than 20ns. Maximum output pin voltage is $V_{CC} + 0.75V$ DC, which may overshoot to 7.0V for pulses of less than 20ns.

4. DC and AC Operating Conditions

| | Commercial | Industrial |
|---------------------------------|------------|--------------|
| Operating Temperature (Ambient) | 0°C - 70°C | -40°C - 85°C |
| V_{CC} Power Supply | 5V ± 5% | 5V ± 10% |

4.1 DC Characteristics

| Symbol | Parameter | Condition | Min | Typ | Max | Units | |
|----------------|-----------------------------------|--|-----------|-----|-----------------|---------|---------|
| I_{IL} | Input or I/O Low Leakage Current | $0 \leq V_{IN} \leq V_{IL} (Max)$ $3.5 \leq V_{IN} \leq V_{CC}$ | | | -10 | μA | |
| I_{IH} | Input or I/O High Leakage Current | | | | 10 | μA | |
| I_{CC} | Clocked Power Supply Current | $V_{CC} = Max$ Outputs Open, $f = 15MHz$ | CZ-12, 15 | Com | 90 | 150 | mA |
| | | | CZ-15 | Ind | 90 | 180 | mA |
| | | | CQZ-20 | Com | 40 | 60 | mA |
| | | | CQZ-20 | Ind | 40 | 80 | mA |
| I_{SB} | Power Supply Current, Standby | $V_{CC} = Max$ $V_{IN} = MAX$ Outputs Open | CZ-12, 15 | Com | 5 | 100 | μA |
| | | | CZ-15 | Ind | 5 | 120 | μA |
| | | | CQZ-20 | Com | 5 | 100 | μA |
| | | | CQZ-20 | Ind | 5 | 120 | μA |
| $I_{OS}^{(1)}$ | Output Short Circuit Current | $V_{OUT} = 0.5V$ | | | -130 | mA | |
| V_{IL} | Input Low Voltage | | -0.5 | | 0.8 | V | |
| V_{IH} | Input High Voltage | | 2.0 | | $V_{CC} + 0.75$ | V | |
| V_{OL} | Output Low Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{CC} = Min,$ $I_{OL} = 16mA$ | | | 0.5 | V | |
| V_{OH} | Output High Voltage | $V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{CCIO} = Min,$ $I_{OH} = -4.0mA$ | 2.4 | | | V | |

Note: 1. Not more than one output at a time should be shorted. Duration of short circuit test should not exceed 30 sec



4.2 AC Waveforms



4.3 AC Characteristics⁽¹⁾

| Symbol | Parameter | -12 | | -15 | | -20 | | Units |
|-----------|---|-----|--------------------|-----|--------------------|-----|----------------------|-------------------|
| | | Min | Max | Min | Max | Min | Max | |
| t_{PD} | Input or Feedback to Non-registered Output | 3 | 12 | 3 | 15 | 3 | 20 | ns |
| t_{CF} | Clock to Feedback | | 6 | | 4.5 | | 8 | ns |
| t_{CO} | Clock to Output | 2 | 8 | 2 | 8 | 2 | 12 | ns |
| t_S | Input or Feedback Setup Time | 10 | | 10 | | 14 | | ns |
| t_H | Input Hold Time | 0 | | 0 | | 0 | | ns |
| t_W | Clock Width | 6 | | 6 | | 10 | | ns |
| f_{MAX} | External Feedback $1/(t_S + t_{CO})$ Internal Feedback $1/(t_S + t_{CF})$ No Feedback $1/(t_P)$ | | 55.5 62 83.3 | | 55.5 69 83.3 | | 38.5 45.5 50.0 | MHz MHz MHz |
| t_{EA} | Input to Output Enable - Product Term | 3 | 12 | 3 | 15 | 3 | 20 | ns |
| t_{ER} | Input to Output Disable - Product Term | 2 | 15 | 3 | 15 | 3 | 20 | ns |
| t_{PZX} | OE Pin to Output Enable | 2 | 12 | 2 | 15 | 2 | 20 | ns |
| t_{PXZ} | OE Pin to Output Disable | 2 | 15 | 2 | 15 | 2 | 20 | ns |
| t_{AP} | Input or I/O to Asynchronous Reset of Register | 3 | 10 | 3 | 15 | 3 | 22 | ns |
| t_{SP} | Setup Time, Synchronous Preset | 10 | | 10 | | 14 | | ns |
| t_{AW} | Asynchronous Reset Width | 7 | | 8 | | 20 | | ns |
| t_{AR} | Asynchronous Reset Recovery Time | 5 | | 6 | | 20 | | ns |
| t_{SPR} | Synchronous Preset to Clock Recovery Time | 10 | | 10 | | 14 | | ns |

Note: 1. See ordering information for valid part numbers

4.4 Input Test Waveforms

4.4.1 Input Test Waveforms and Measurement Levels



4.4.2 Output Test Loads



Note: Similar competitor devices are specified with slightly different loads. These load differences may affect output signals' delay and slew rate. Atmel devices are tested with sufficient margins to meet compatible device specification conditions.

4.5 Pin Capacitance

Table 4-1. Pin Capacitance ($f = 1\text{MHz}$, $T = 25\text{C}^{(1)}$)

| | Typ | Max | Units | Conditions |
|------------------|-----|-----|-------|--|
| C_{IN} | 8 | 10 | pF | $V_{\text{IN}} = 0\text{V}$; $f = 1.0\text{MHz}$ |
| $C_{\text{I/O}}$ | 8 | 10 | pF | $V_{\text{OUT}} = 0\text{V}$; $f = 1.0\text{MHz}$ |

Note: 1. Typical values for nominal supply voltage. This parameter is only sampled and is not 100% tested

4.6 Power-up Reset

The registers in the Atmel® ATF22V10CZ/CQZ are designed to reset during power-up. At a point delayed slightly from V_{CC} crossing V_{RST} , all registers will be reset to the low state. The output state will depend on the polarity of the buffer.

This feature is critical for state machine initialization. However, due to the asynchronous nature of reset and the uncertainty of how V_{CC} actually rises in the system, the following conditions are required:

1. The V_{CC} rise must be monotonic and start below 0.7V
2. The clock must remain stable during T_{PR}
3. After T_{PR} occurs, all input and feedback setup times must be met before driving the clock pin high

4.7 Preload of Register Outputs

The ATF22V10CZ/CQZ's registers are provided with circuitry to allow loading of each register with either a high or a low. This feature will simplify testing since any state can be forced into the registers to control test sequencing. A JEDEC file with preload is generated when a source file with vectors is compiled. Once downloaded, the JEDEC file preload sequence will be done automatically by most of the approved programmers after the programming.

5. Electronic Signature Word

There are 64-bits of programmable memory that are always available to the user, even if the device is secured. These bits can be used for user-specific data.

6. Security Fuse Usage

A single fuse is provided to prevent unauthorized copying of the Atmel® ATF22V10CZ/CQZ fuse patterns. Once programmed, fuse verify and preload are inhibited. However, the 64-bit User Signature remains accessible. The security fuse should be programmed last, as its effect is immediate.

7. Programming/Erasing

Programming/erasing is performed using standard PLD programmers. See CMOS PLD Programming Hardware and Software Support for information on software/programming.

Figure 7-1. Programming/Erasing Timing



Table 7-1. Programming/Erasing

| Parameter | Description | Typ | Max | Units |
|-----------|------------------------|-----|------|-------|
| T_{PR} | Power-up Reset Time | 600 | 1000 | ns |
| V_{RST} | Power-up Reset Voltage | 3.8 | 4.5 | V |

8. Input and I/O Pull-ups

All Atmel® ATF22V10CZ/CQZ family members have internal input and I/O pin-keeper circuits. Therefore, whenever inputs or I/Os are not being driven externally, they will maintain their last driven state. This ensures that all logic array inputs and device outputs are at known states. These are relatively weak active circuits that can be easily overridden by TTL-compatible drivers (see input and I/O diagrams below).

Figure 8-1. Input Diagram



Figure 8-2. I/O Diagram



9. Compiler Mode Selection

Table 9-1. Compiler Mode Selection

| | PAL Mode (5828 Fuses) | GAL Mode (5892 Fuses) |
|----------|---|---|
| Synario | Atmel ATF22V10C (DIP) Atmel ATF22V10C (PLCC) | Atmel ATF22V10C DIP (UES) Atmel ATF22V10C PLCC (UES) |
| WINCUPPL | P22V10 P22V10LCC | G22V10 G22V10LCC |

10. Functional Logic Diagram Description

The Functional Logic Diagram describes the Atmel® ATF22V10CZ/CQZ architecture.

The ATF22V10CZ/CQZ has 12 inputs and 10 I/O macrocells. Each macrocell can be configured into one of four output configurations: active high/low, registered/combinatorial output. The universal architecture of the ATF22V10CZ/CQZ can be programmed to emulate most 24-pin PAL devices.

Unused product terms are automatically disabled by the compiler to decrease power consumption. A security fuse, when programmed, protects the contents of the ATF22V10CZ/CQZ. Eight bytes (64-fuses) of User Signature are accessible to the user for purposes such as storing project name, part number, revision or date. The User Signature is accessible regardless of the state of the security fuse.

Figure 10-1. Functional Logic Diagram







**ATMEL ATF22V10C
DELTA T_{PD} vs. OUTPUT LOADING**



**ATMEL ATF22V10C
DELTA T_{CO} vs. OUTPUT LOADING**



DELTA T_{PD} vs. # OF OUTPUT SWITCHING



DELTA T_{CO} vs. # OF OUTPUT SWITCHING



11. Ordering Information

11.1 Standard Package Options

| t_{PD} (ns) | t_S (ns) | t_{CO} (ns) | Ordering Code | Package | Operation Range |
|------------------|---------------|------------------|--|---------------------------|--------------------------------|
| 12 | 10 | 8 | ATF22V10CZ-12JC ATF22V10CZ-12PC ATF22V10CZ-12SC ATF22V10CZ-12XC | 28J 24P3 24S 24X | Commercial (0-C to 70-C) |
| 15 | 10 | 8 | ATF22V10CZ-15JC ATF22V10CZ-15PC ATF22V10CZ-15SC | 28J 24P3 24S | Commercial (0-C to 70-C) |
| | | | ATF22V10CZ-15JI ATF22V10CZ-15PI ATF22V10CZ-15SI | 28J 24P3 24S | Industrial (-40-C to +85-C) |
| 20 | 14 | 12 | ATF22V10CQZ-20JC ATF22V10CQZ-20PC ATF22V10CQZ-20SC ATF22V10CQZ-20XC | 28J 24P3 24S 24X | Commercial (0-C to 70-C) |
| | | | ATF22V10CQZ-20JI ATF22V10CQZ-20PI ATF22V10CQZ-20SI ATF22V10CQZ-20XI | 28J 24P3 24S 24X | Industrial (-40-C to +85-C) |

Note: Shaded parts are being obsoleted and are not recommended for new designs. Customers should transition to ROHS offering

11.2 Atmel ATF22V10CQZ Green Package Options (Pb/Halide-free/RoHS Compliant)

| t_{PD} (ns) | t_S (ns) | t_{CO} (ns) | Ordering Code | Package | Operation Range |
|------------------|---------------|------------------|--|---------------------------|--------------------------------|
| 20 | 14 | 12 | ATF22V10CQZ-20JU ATF22V10CQZ-20PU ATF22V10CQZ-20SU ATF22V10CQZ-20XU | 28J 24P3 24S 24X | Industrial (-40-C to +85-C) |

11.3 Using “C” Product for Industrial

To use commercial product for Industrial temperature ranges, down-grade one speed grade from the “I” to the “C” device (7ns “C” = 10ns “I”) and de-rate power by 30%.

| Package Type | |
|--------------|--|
| 28J | 28-lead, Plastic J-leded Chip Carrier (PLCC) |
| 24P3 | 24-pin, 0.300", Plastic Dual Inline Package (PDIP) |
| 24S | 24-lead, 0.300" Wide, Plastic Gull-Wing Small Outline (SOIC) |
| 24X | 24-lead, 4.4mm Wide, Plastic Thin Shrink Small Outline (TSSOP) |

12. Packaging Information

12.1 28J – PLCC



COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|-----------|-----|--------|--------|
| A | 4.191 | – | 4.572 | |
| A1 | 2.286 | – | 3.048 | |
| A2 | 0.508 | – | – | |
| D | 12.319 | – | 12.573 | |
| D1 | 11.430 | – | 11.582 | Note 2 |
| E | 12.319 | – | 12.573 | |
| E1 | 11.430 | – | 11.582 | Note 2 |
| D2/E2 | 9.906 | – | 10.922 | |
| B | 0.660 | – | 0.813 | |
| B1 | 0.330 | – | 0.533 | |
| e | 1.270 TYP | | | |

- Notes:
1. This package conforms to JEDEC reference MS-018, Variation AB.
 2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is .010" (0.254mm) per side. Dimension D1 and E1 include mold mismatch and are measured at the extreme material condition at the upper or lower parting line.
 3. Lead coplanarity is 0.004" (0.102mm) maximum.

10/04/01



Package Drawing Contact:
packagedrawings@atmel.com

TITLE

28J, 28-lead, Plastic J-leaded Chip Carrier (PLCC)

DRAWING NO.

28J

REV.

B

12.2 24P3 – PDIP



COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|-----------|-----|--------|--------|
| A | – | – | 5.334 | |
| A1 | 0.381 | – | – | |
| D | 31.623 | – | 32.131 | Note 2 |
| E | 7.620 | – | 8.255 | |
| E1 | 6.096 | – | 7.112 | Note 2 |
| B | 0.356 | – | 0.559 | |
| B1 | 1.270 | – | 1.651 | |
| L | 2.921 | – | 3.810 | |
| C | 0.203 | – | 0.356 | |
| eB | – | – | 10.922 | |
| eC | 0.000 | – | 1.524 | |
| e | 2.540 TYP | | | |

- Notes:
1. This package conforms to JEDEC reference MS-001, Variation AF.
 2. Dimensions D and E1 do not include mold Flash or Protrusion. Mold Flash or Protrusion shall not exceed 0.25mm (0.010").

6/1/04



Package Drawing Contact:
packagedrawings@atmel.com

TITLE
24P3, 24-lead (0.300"/7.62mm Wide) Plastic Dual
Inline Package (PDIP)

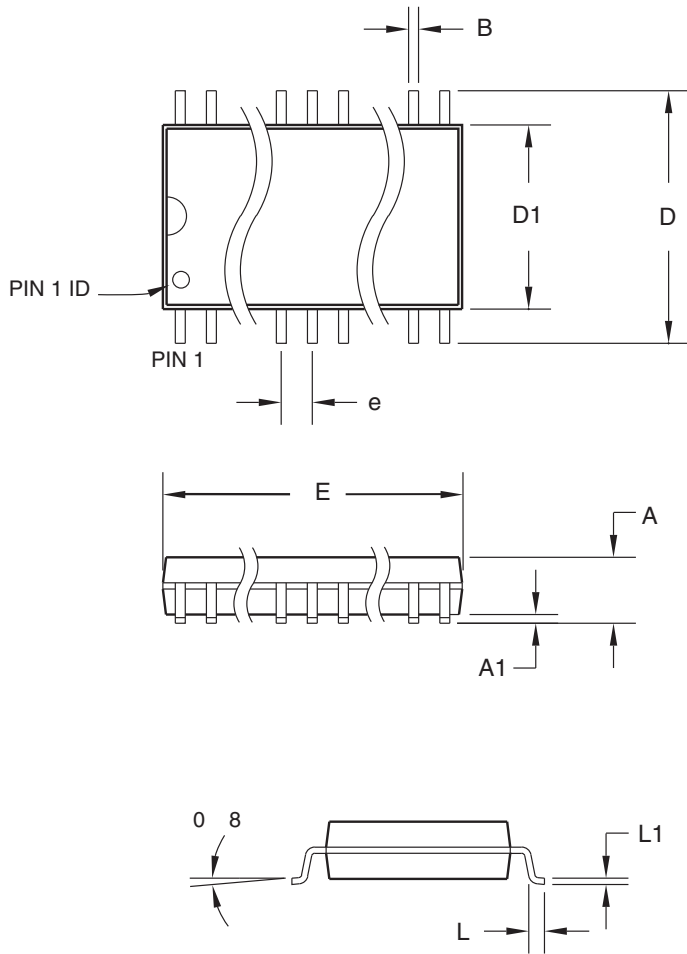
DRAWING NO.

24P3

REV.

D

12.3 24S – SOIC



COMMON DIMENSIONS
(Unit of Measure = mm)

| SYMBOL | MIN | NOM | MAX | NOTE |
|--------|----------|-----|-------|------|
| A | – | – | 2.65 | |
| A1 | 0.10 | – | 0.30 | |
| D | 10.00 | – | 10.65 | |
| D1 | 7.40 | – | 7.60 | |
| E | 15.20 | – | 15.60 | |
| B | 0.33 | – | 0.51 | |
| L | 0.40 | – | 1.27 | |
| L1 | 0.23 | – | 0.32 | |
| e | 1.27 BSC | | | |

06/17/2002



Package Drawing Contact:
packagedrawings@atmel.com

TITLE
24S, 24-lead (0.300" body) Plastic Gull Wing Small
Outline (SOIC)

| DRAWING NO. | REV. |
|-------------|------|
| 24S | B |

12.4 24X – TSSOP

Dimensions in Millimeter and (Inches)*
 JEDEC STANDARD MO-153 AD
 Controlling dimension: millimeters



04/11/2001



Package Drawing Contact:
 packagedrawings@atmel.com

TITLE
 24X, 24-lead (4.4mm body width) Plastic Thin Shrink
 Small Outline Package (TSSOP)

DRAWING NO.

24X

REV.

A



13. Revision History

| Doc. Rev. | Date | Comments |
|-----------|---------|---|
| 0778L | 08/2010 | Change t_s (ns) from 4.5 to 10 in Standard Package Options. 06/2014 The ATF22V10CZ is obsolete. Replaced by ATF22V10CQZ. |
| 0778K | 07/2010 | Remove Commercial Temperature Range For I_{SB} , change 25 μ A Max to 100 μ A max for commercial grade parts and 50 μ A Max to 120 μ A for Industrial grade parts Shade Standard Package Options and add note, "Shaded parts are not recommended for new designs. Customers should transition to ROHS offering" Remove Atmel ATF22V10CZ-15XC and Atmel ATF22V10CZ-15XI from Standard Package Options |
| 0778J | 11/2005 | Add Green Package options |



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